

2SK3845

Switching Regulator, DC-DC Converter Applications and Motor Drive Applications

- Low drain-source ON resistance: $R_{DS(ON)} = 4.7 \text{ m}\Omega$ (typ.)
- High forward transfer admittance: $|Y_{fs}| = 88 \text{ S}$ (typ.)
- Low leakage current: $I_{DSS} = 100 \text{ }\mu\text{A}$ (max) ($V_{DS} = 60 \text{ V}$)
- Enhancement model: $V_{th} = 2.0 \text{ to } 4.0 \text{ V}$ ($V_{DS} = 10 \text{ V}$, $I_D = 1 \text{ mA}$)

Absolute Maximum Ratings (Ta = 25°C)

| Characteristics | | Symbol | Rating | Unit |
|--|----------------|-----------|------------|------------------|
| Drain-source voltage | | V_{DSS} | 60 | V |
| Drain-gate voltage ($R_{GS} = 20\text{ k}\Omega$) | | V_{DGR} | 60 | V |
| Gate-source voltage | | V_{GSS} | ± 20 | V |
| Drain current | DC (Note 1) | I_D | 70 | A |
| | Pulse (Note 1) | I_{DP} | 280 | |
| Drain power dissipation ($T_c = 25^\circ\text{C}$) | | P_D | 125 | W |
| Single pulse avalanche energy (Note 2) | | E_{AS} | 328 | mJ |
| Avalanche current | | I_{AR} | 70 | A |
| Repetitive avalanche energy (Note 3) | | E_{AR} | 12.5 | mJ |
| Channel temperature | | T_{ch} | 150 | $^\circ\text{C}$ |
| Storage temperature range | | T_{stg} | -55 to 150 | $^\circ\text{C}$ |

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/Derating Concept and Methods) and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Thermal Characteristics

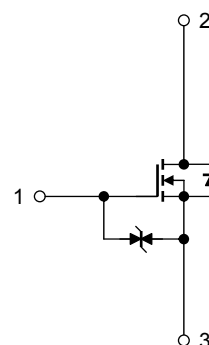
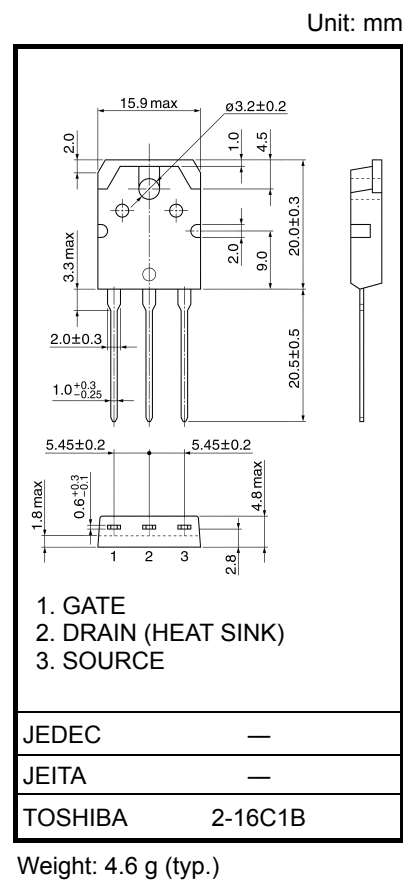
| Characteristics | Symbol | Max | Unit |
|--|----------------|-----|------|
| Thermal resistance, channel to case | $R_{th(ch-c)}$ | 1.0 | °C/W |
| Thermal resistance, channel to ambient | $R_{th(ch-a)}$ | 50 | °C/W |

Note 1: Ensure that the channel temperature does not exceed 150°C.

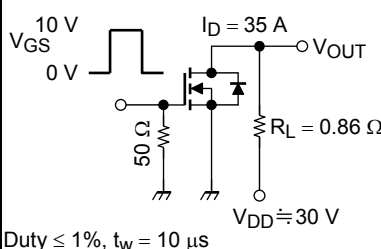
Note 2: $V_{DD} = 25 \text{ V}$, $T_{ch} = 25^\circ\text{C}$ (initial), $L = 91 \text{ } \mu\text{H}$, $R_G = 25 \text{ } \Omega$, $I_{AB} = 70 \text{ A}$

Note 3: Repetitive rating: pulse width limited by maximum channel temperature

This transistor is an electrostatic-sensitive device. Please handle with caution.



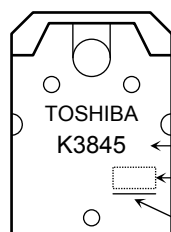
Electrical Characteristics (Ta = 25°C)

| Characteristics | | Symbol | Test Condition | Min | Typ. | Max | Unit |
|---|----------------|--------------|--|-----|-------|----------|------------------|
| Gate leakage current | | I_{GSS} | $V_{GS} = \pm 16 \text{ V}, V_{DS} = 0 \text{ V}$ | — | — | ± 10 | μA |
| Drain cut-OFF current | | I_{DSS} | $V_{DS} = 60 \text{ V}, V_{GS} = 0 \text{ V}$ | — | — | 100 | μA |
| Drain-source breakdown voltage | $V_{(BR) DSS}$ | | $I_D = 10 \text{ mA}, V_{GS} = 0 \text{ V}$ | 60 | — | — | V |
| | $V_{(BR) DSX}$ | | $I_D = 10 \text{ mA}, V_{GS} = -20 \text{ V}$ | 35 | — | — | |
| Gate threshold voltage | | V_{th} | $V_{DS} = 10 \text{ V}, I_D = 1 \text{ mA}$ | 2.0 | — | 4.0 | V |
| Drain-source ON resistance | | $R_{DS(ON)}$ | $V_{GS} = 10 \text{ V}, I_D = 35 \text{ A}$ | — | 4.7 | 5.8 | $\text{m}\Omega$ |
| Forward transfer admittance | | $ Y_{fs} $ | $V_{DS} = 10 \text{ V}, I_D = 35 \text{ A}$ | 44 | 88 | — | S |
| Input capacitance | | C_{iss} | $V_{DS} = 10 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$ | — | 12400 | — | pF |
| Reverse transfer capacitance | | C_{rss} | | — | 700 | — | |
| Output capacitance | | C_{oss} | | — | 1100 | — | |
| Switching time | Rise time | t_r |  | — | 17 | — | ns |
| | Turn-on time | t_{on} | | — | 44 | — | |
| | Fall time | t_f | | — | 35 | — | |
| | Turn-off time | t_{off} | | — | 200 | — | |
| Total gate charge (gate-source plus gate-drain) | | Q_g | $V_{DD} \approx 48 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 70 \text{ A}$ | — | 196 | — | nC |
| Gate-source charge | | Q_{gs} | | — | 148 | — | |
| Gate-drain ("miller") charge | | Q_{gd} | | — | 48 | — | |

Source-Drain Ratings and Characteristics (Ta = 25°C)

| Characteristics | Symbol | Test Condition | Min | Typ. | Max | Unit |
|---|-----------|--|-----|------|------|------|
| Continuous drain reverse current (Note 1) | I_{DR} | — | — | — | 70 | A |
| Pulse drain reverse current (Note 1) | I_{DRP} | — | — | — | 280 | A |
| Forward voltage (diode) | V_{DSF} | $I_{DR} = 70 \text{ A}, V_{GS} = 0 \text{ V}$ | — | — | -1.5 | V |
| Reverse recovery time | t_{rr} | $I_{DR} = 70 \text{ A}, V_{GS} = 0 \text{ V},$ | — | 70 | — | ns |
| Reverse recovery charge | Q_{rr} | $dI_{DR}/dt = 50 \text{ A}/\mu\text{s}$ | — | 77 | — | nC |

Marking



Part No. (or abbreviation code)

Lot No.

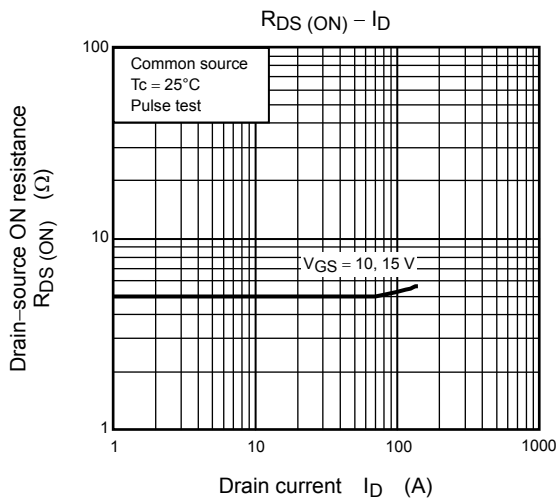
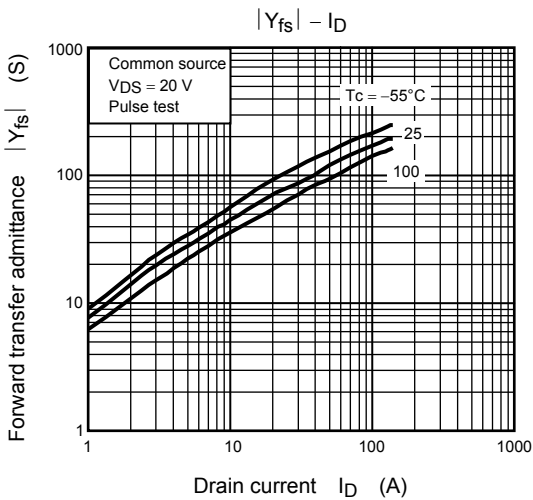
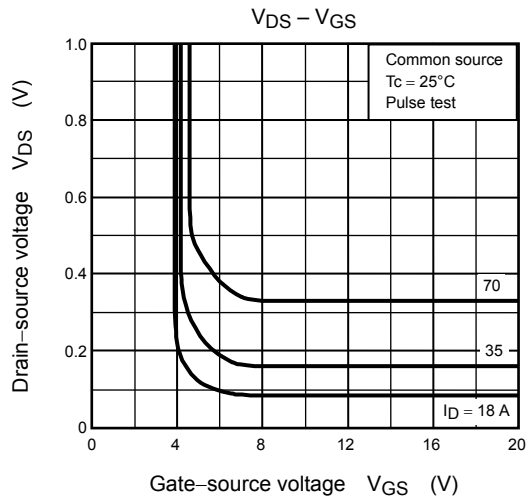
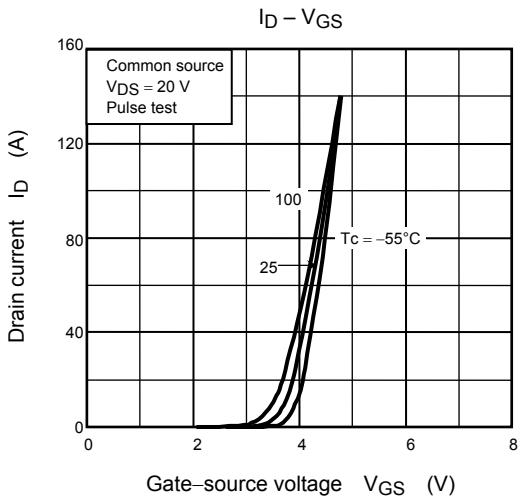
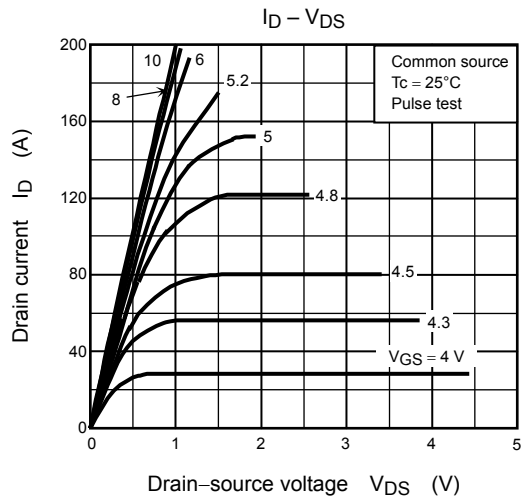
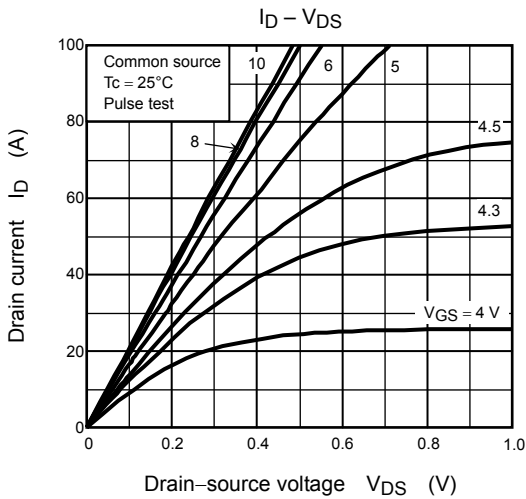
Note 4

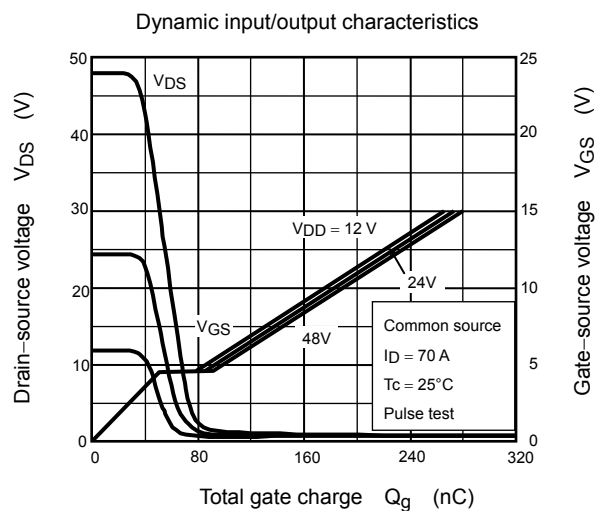
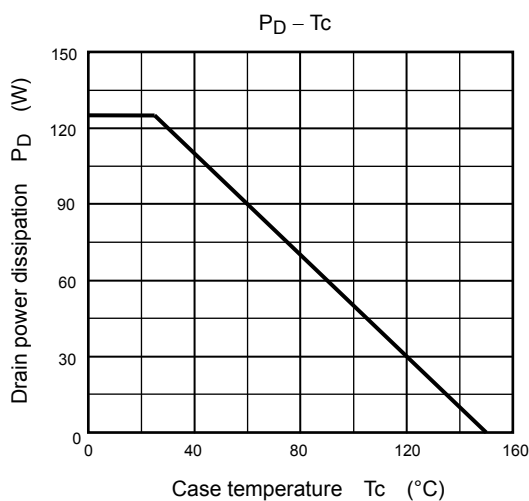
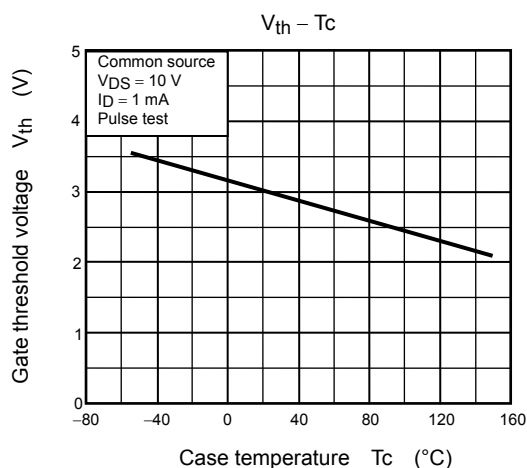
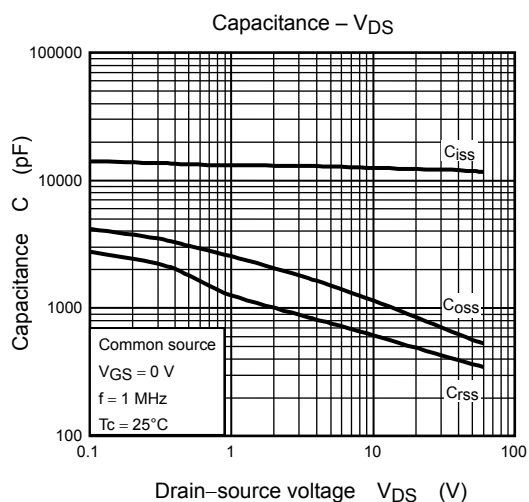
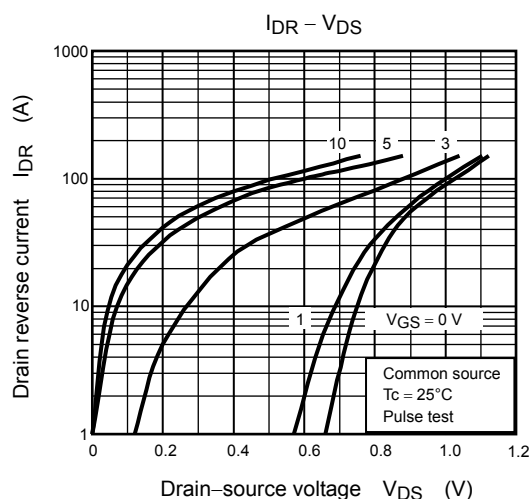
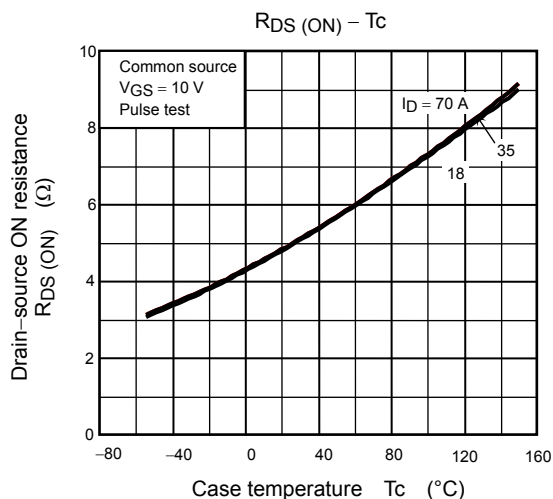
Note 4: A line under a Lot No. identifies the indication of product Labels.

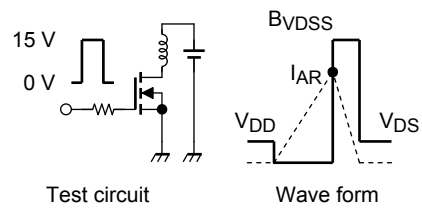
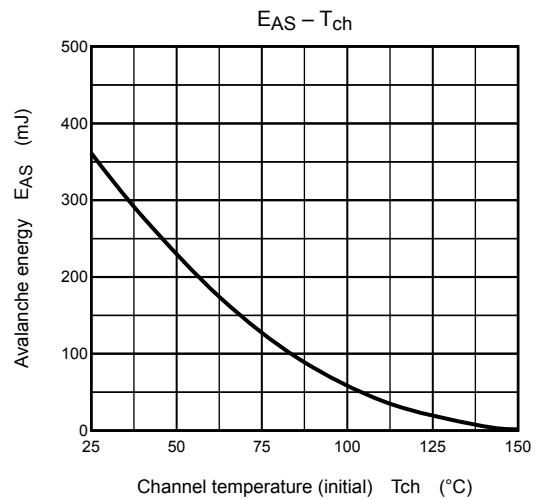
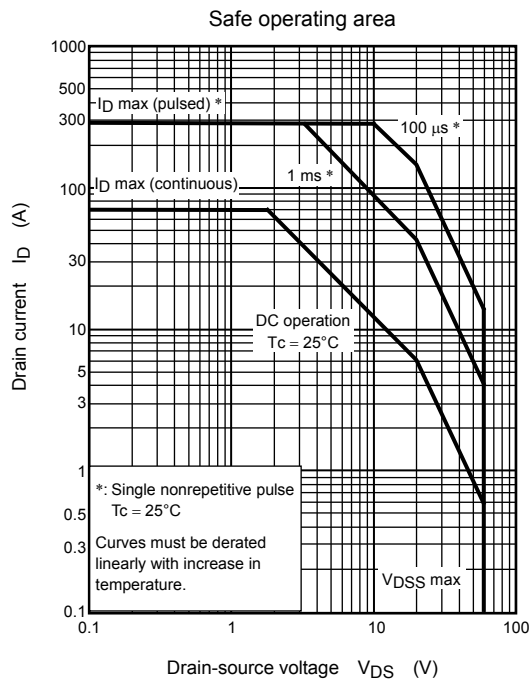
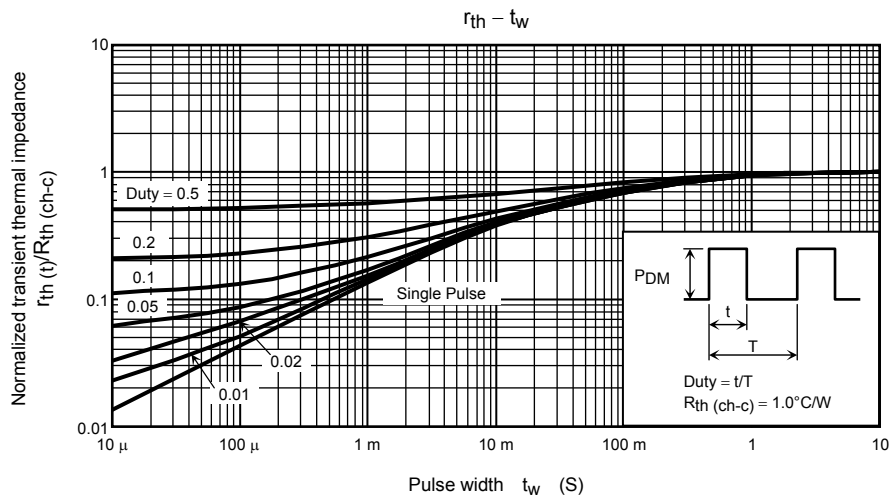
Not underlined: $[[Pb]]/INCLUDES > MCV$

Underlined: $[[G]]/RoHS COMPATIBLE$ or $[[G]]/RoHS [[Pb]]$

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$$R_G = 25 \Omega$$

$$V_{DD} = 25 V, L = 91 \mu H$$

$$E_{AS} = \frac{1}{2} \cdot L \cdot I_{AR}^2 \cdot \left(\frac{B_{VDSS}}{B_{VDSS} - V_{DD}} \right)$$

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